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Bib Data Sheet

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APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*

\*\* FOREIGN APPLICATIONS \*\*\*\*\*  
 JAPAN 2003-011017 01/20/2003 *Yes.*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 04/13/2004

|  |  |                              |                         |                       |                            |
|--|--|------------------------------|-------------------------|-----------------------|----------------------------|
| Foreign Priority claimed<br>35 USC 119 (a-d) conditions met<br>Verified and Acknowledged | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no<br><input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance<br><i>[Signature]</i><br>Examiner's Signature Initials | STATE OR<br>COUNTRY<br>JAPAN | SHEETS<br>DRAWING<br>12 | TOTAL<br>CLAIMS<br>12 | INDEPENDENT<br>CLAIMS<br>2 |
|--|--|------------------------------|-------------------------|-----------------------|----------------------------|

ADDRESS

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TITLE

Semiconductor substrate, method for fabricating the same, and method for fabricating semiconductor device

|                                   |   |  |
|-----------------------------------|---|--|
| FILING FEE<br><br>RECEIVED<br>770 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue ) |
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